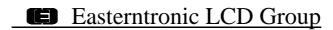
PRODUCT SPECIFIICATION

GS16032A-D-BSXTSWW-100

V1.1

September 9, 2006



REVISION RECORD

REV	DESCRIPTION	DATA
V1.0 V1.1	 First Issue Modify 4.2 "Electronic Block Diagram", and indicate that the number of LED BackLight is only one. Add 4.3 "Power Supply For LCD Module". Modify 6.1 "Electrical Characteristics", and add Min and Max Supply Voltage of LED. 	September 7, 2006 September 9, 2006

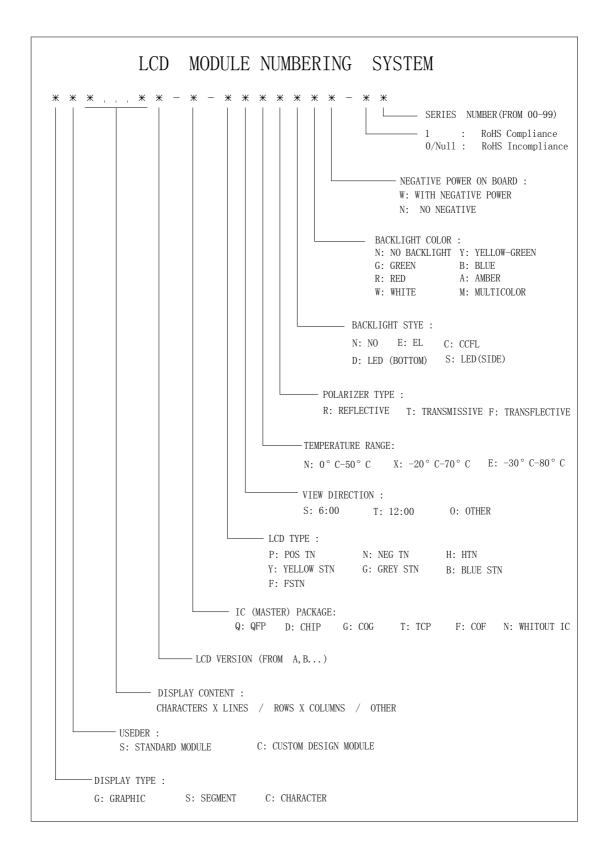
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Type Number and Description

Type Number:	GS16032A-D-BSXTSWW-100
Description:	160 X 32 DOTS
LCD Panel:	STN ,Blue Negative
Operating Temperature:	$-20\ {}^{0}\mathrm{C} - 70\ {}^{0}\mathrm{C}$
Storage Temperature:	$-30\ {}^{0}\mathrm{C} - 80\ {}^{0}\mathrm{C}$
Viewing angle:	6H
BackLight Mode:	Side
BackLight Color:	White
Controller:	ST7920
IC Package:	Bonding
Logic Voltage:	5.0V
DC-DC Converter:	With

2. LCD Module Numbering System



з.	Mechanical Specifications:		
	ITEM	STANDARD VALUE	UNIT
	Display Content	160 x 32 dots	
	MODULE DIMENSION	116.0(W) X 37.0(H) X13.0(T)	mm
	EFFECTTVE DISPLAY AREA	86.0(W) X 19.5(H)	mm
	DOT SIZE	0.45(W) X 0.45(H)	mm
	DOT PITCH	0.50(W) X 0.50(H)	mm
	APPROX WEIGHT	80G	g
	LCD TYPE	STN,Blue	

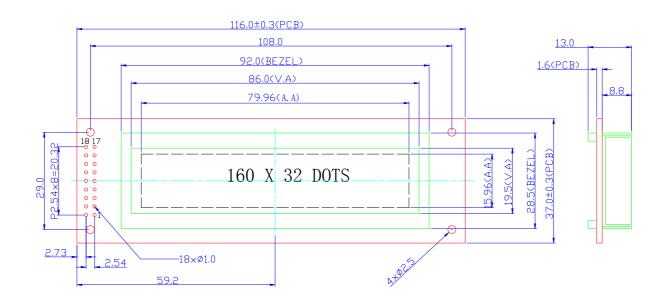
6:00

3. Mechanical Specifications:

DUTY AND BIAS

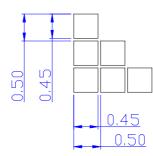
BACK LIGHT

VIEWING DIRECTION



1/33 DUTY; 1/5 BIAS

White, Side LED

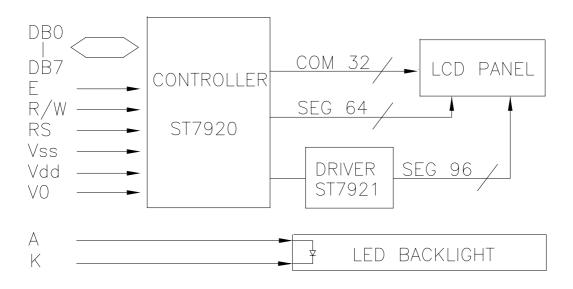


4. Electrical Block Diagram

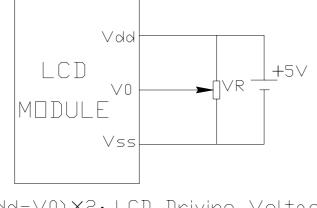
4.1 PINS DEFINITION

PIN	SYMBOL	SIGNAL DESCRIPTION				
1	VSS	GND (OV)				
2	VDD	Power Supply for Logic				
3	VO	Operating Voltage for LCD				
4	D/I	H:Data L:Instrction				
5	R/W	H:MPU<-Module L:MPU->Module				
6	Е	Enable Signal				
7-14	DBO-DB7	Data Bus				
15	/RST	Reset Signal				
16	NC	NO Connection				
17	А	Supply Voltage for BackLight (+)				
18	K	Supply Voltage for BackLight(-)				

4.2 ELECTRICAL BLOCK DIAGRAM



4.3 POWER SUPPLY FOR LCD MODULE



(Vdd-V0)×2:LCD Driving Voltage VR:10K-20K

5. Absolute Maximum Ratings

5.1 Electrical Maximum Ratings

ITEM	SYMBOL	CONDITION	MIN	MAX	UNIT
Supply Voltage (Logic)	Vdd – Vss	-	-0.3	5.5	V
Supply Voltage (LCD Drive)	Vdd - V0	-	-0.3	7.0	V
Input Voltage	Vi	-	-0.3	Vdd +0.3	V

5.2 Environmental Conditions

ITEM	SYMBOL	CONDITION	MIN	MAX	UNIT
Operating Temp	Topr	-	-20	70	deg C
Storage Temp	Ttsg	-	-30	80	deg C
Humidity	RH	no ondensation	-	95	%
Endurance		Ta =40 deg</td <td></td> <td></td> <td></td>			
Vibration	-	3 directions	see no	ote (a), page 3	-
Shock	-	3 directions	see no	ote (b), page 3	-

note (a): frequency : varying from 10 Hz in a 1-minute cycle

amplitude : 1.5mm

duration : 120 cycles, each lasting 1 minute,

for each of the 3 directions, x,y,z

note (b): nutually perpendicular directions

direction normal to surface of LCD glass

80G, half-sine pulse of duration 11ms

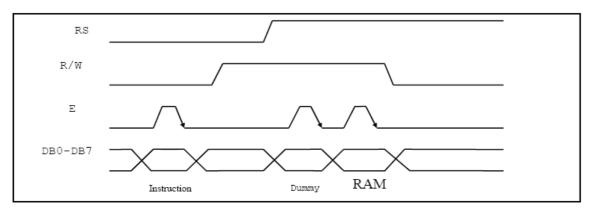
other 2 directions

100G, half-sine pulse of duration 11ms

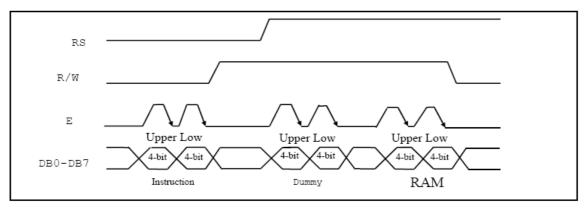
6. Electrical Specifications

ITEM	SYMBOL	CONDITION	MIN	ТҮР	MAX	UNIT
Supply Voltage (logic)	Vdd-Vss	-	4.5	5	5.5	V
Supply Voltage (LED)	V-bl	see note 1	2.9	3.2	3.5	V
Supply Current (LED)	I-bl	see note 1	-	15	25	mA

6.2 Parallel Interface

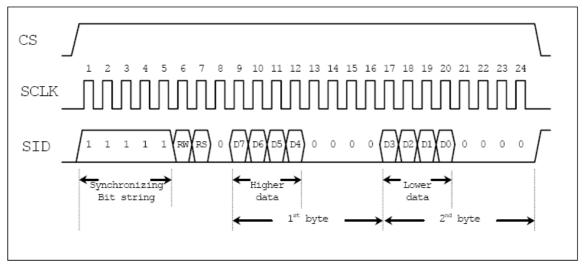


Timing Diagram of 8-bit Parallel Bus Mode Data Transfer



Timing Diagram of 4-bit Parallel Bus Mode Data Transfer

6.3 Serial Interface



Timing Diagram of Serial Mode Data Transfer

ITEM	SYMB OL	CONDI TION	MIN.	TYP.	MAX.	UNIT	REF.
Contrast	CR	25℃		12			Note1
Rise Time	tr	25℃		160	240	ms	Note2
Fall Time	tf	25℃		100	150	ms	note 2
	θ 1- θ				60		
Viewing Angle	2	25℃				DEG	Note 3
	Ø1, Ø2		-40		40		
Frame	Ff	25℃		70		Hz	note 2
Frequency							

Note(3): Contrast ratio is defined under the following condition:

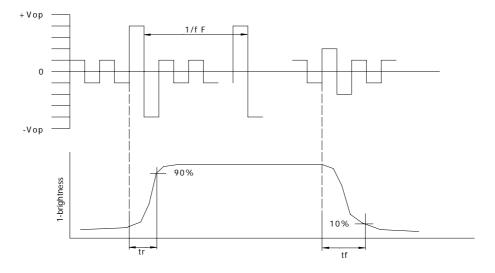
CR= brightness of non-selected condition

brightness of non-selected condition

- (a). Temperature-----25C
- (b). Frame Frequency-----64Hz

- (c). Viewing angle----- $\theta = 0, \emptyset = 0$
- (d). Operating Voltage---5.0V

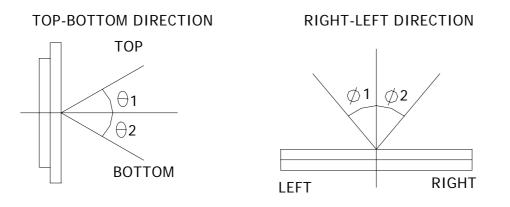
Note(1): definition of response time:



Condition:

- (a). Temperature-----25C
- (b). Frame Frequency-----64Hz
- (c). Viewing angle----- $\theta = 0, \emptyset = 0$
- (d). Operating Voltage---5.0V

Note(2): definition of view



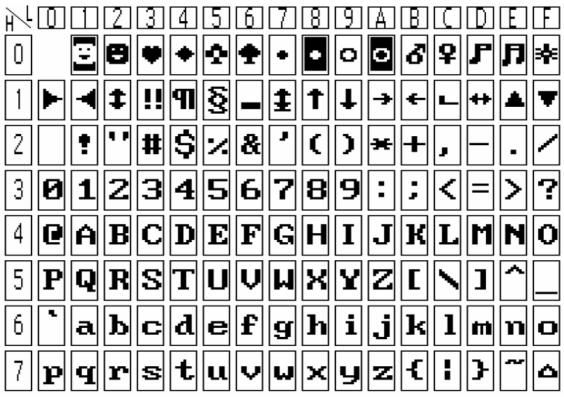
8. Instruction Table

Ins					co	de					Description	Exec time
	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0		(540KHZ)
CLEAR	0	0	0	0	0	0	0	0	0	1	Fill DDRAM with "20H", and set DDRAM address counter (AC) to "00H"	1.6 ms
HOME	0	0	0	0	0	0	0	0	1	х	Set DDRAM address counter (AC) to "00H", and put cursor to origin ; the content of DDRAM are not changed	72 u s
ENTRY MODE	0	0	0	0	0	0	0	1	I/D	s	Set cursor position and display shift when doing write or read operation	72us
DISPLAY ON/OFF	0	0	0	0	0	0	1	D	с	в	D=1: display ON C=1: cursor ON B=1: blink ON	72 us
CURSOR DISPLAY CONTROL	0	0	0	0	0	1	S/C	R/L	x	x	Cursor position and display shift control ; the content of DDRAM are not changed	72 us
FUNCTION SET	0	0	0	0	1	DL	x	0 RE	x	x	DL=1 8-BIT interface DL=0 4-BIT interface RE=1: extended instruction RE=0: basic instruction	72 us
SET CGRAM ADDR.	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	Set CGRAM address to address counter (AC) Make sure that in extended instruction SR=0 (scroll or RAM address select)	72 us
SET DDRAM ADDR.	0	0	1	0 AC6	AC5	AC4	AC3	AC2	AC1	AC0	Set DDRAM address to address counter (AC) AC6 is fixed to 0	72 us
READ BUSY FLAG (BF) & ADDR.	0	1	BF	AC6	AC5	AC4	AC3	AC2	AC1	AC0	Read busy flag (BF) for completion of internal operation, also Read out the value of address counter (AC)	0 us
WRITE RAM	1	0	D7	D6	D5	D4	D3	D2	D1	D0	Write data to internal RAM (DDRAM/CGRAM/IRAM/GDRAM)	72 us
READ RAM	1	1	D7	D6	D5	D4	D3	D2	D1	D0	Read data from internal RAM (DDRAM/CGRAM/IRAM/GDRAM)	72 us

Instruction set 1: (RE=0: basic instruction)

Inst.	code										description	Exec. time
	RS	RW	DB7	DB6	DB5	DB4	DB3	DB2	DB1	DB0	-	(540KHZ)
STAND BY	0	0	0	0	0	0	0	0	0	1	Enter stand by mode, any other instruction can terminate (Com132 halted, only Com33 ICON can display)	72 us
SCROLL or RAM ADDR. SELECT	0	0	0	0	0	0	0	0	1	SR	SR=1: enable vertical scroll position SR=0: enable IRAM address <u>(extended instruction)</u> SR=0: enable CGRAM address <u>(basic instruction)</u>	72 us
REVERSE	0	0	0	0	0	0	0	1	R1	R0	Select 1 out of 4 line (in DDRAM) and decide whether to reverse the display by toggling this instruction R1,R0 initial value is 00	72 us
EXTENDED FUNCTION SET		0	0	0	1	DL	x	1 RE	G	0	DL=1 8-BIT interface DL=0 4-BIT interface <u>RE=1: extended instruction set</u> <u>RE=0: basic instruction set</u> G=1 :graphic display ON G=0 :graphic display OFF	72 us
SET IRAM or SCROLL ADDR	0	0	0	1	AC5	AC4	AC3	AC2	AC1	AC0	SR=1: AC5~AC0 the address of vertical scroll SR=0: AC3~AC0 the address of ICON RAM	72 us
SET GRAPHIC RAM ADDR.	0	0	1	0	0 AC5				AC1 AC1		consecutive writing	72 us

Instruction set 2: (RE=1: extended instruction)



9. Standard character pattern

Table 7 16x8 half-height characters

10. Precaution For Using LCM

1. LIQUID CRYSTAL DISPLAY (LCD)

LCD is made up of glass, organic sealant, organic fluid, and polymer based polarizers. The following precautions should be taken when handing,

(1). Keep the temperature within range of use and storage. Excessive temperature and humidity could cause polarization degredation, polarizer peel off or bubble.

(2). Do not contact the exposed polarizers with anything harder than an HB pencil lead. To clean dust off the display surface. Wipe gently with cotton. Chamois or other soft material soaked in petroleum benzin.

(3). Wipe off saliva or water drops immediately. Contact with water over a long period of time may cause polarizer deformation or color fading, while an active LCD with water condensation on its surface will cause corrosion of ITO electrodes.

(4). Glass can be easily chipped or cracked from rough handing. especially at corners and edges.

(5). Do not drive LCD with DC voltage.

2. Liquid Crystal Display Modules

2.1 Mechanical Considerations

LCM are assembled and adjusted with a high degree of precision. Avoid excessive shocks and do not make any alterations or modifications. The following should be noted.

(1). Do not tamper in any way with the tabs on the tabs on the metal frame.

(2). Do not modify the PCB by drilling extra holes, changing its outline, moving its components or modifying its pattem.

(3). Do not touch the elastomer connector, especially insert an backlight panel (for example, EL).

(4). When mounting a LCM make sure that the PCB is not under any tress such as bending or twisting. Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.

(5). Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing piels.

2.2. Static Electricity

LCM contains CMOS LSI's and the same precaution for such devices should apply, namely

(1). The operator should be grounded whenever he/she comes into contact with the module. Never touch any of the conductive parts such as the LSI pads, the copper leads on the PCB and the interface terminals with any parts of the human body.

(2). The modules should be kept in antistatic bags or other containers resistant to static for

storage.

(3). Only properly grounded soldering irons should be used.

(4). If an electric screwdriver is used, it should be well grounded and shielded from commutator sparks.

(5). The normal static prevention measures should be observed for work clothes and working benches; for the latter conductive (rubber) mat is recommended.

(6). Since dry air is inductive to statics, a relative humidity of 50-60% is recommended.

2.3. Soldering

(1). Solder only to the I/O terminals.

(2). Use only soldering irons with proper grounding and no leakage.

(3). Soldering temperature: 280 $^{\circ}C \pm 10^{\circ}C$

(4). Soldering time: 3 to 4 sec.

(5). Use eutectic solder with resin flux fill.

(6). If flux is used, the LCD surface should be covered to avoid flux spatters. Flux residue should be removed after wards.

2.4. Operation

(1). The viewing angle can be adjusted by varying the LCD driving voltage V0.

(2). Driving voltage should be kept within specified range; excess voltage shortens display life.

(3). Response time increases with decrease in temperature.

(4). Display may turn black or dark blue at temperatures above its operational range; this is (however not pressing on the viewing area) may cause the segments to appear "fractured".

(5). Mechanical disturbance during operation (such as pressing on the viewing area) nay cause the segments to appear "fractured".

2.5. Storage

If any fluid leaks out of a damaged glass cell, wash off any human part that comes into contact with soap and water. Never swallow the fluid. The toxicity is extremely low but caution should be exercised at all the time.

2.6. Limited Warranty

Unless otherwise agreed between EASTERNTRONIC customer, and EASTERNTRONIC will replace or repair any of its LCD and LC, which is found to be defective electrically and visually when inspected in accordance with EASTERNTRONIC acceptance standards, for a period on one year fron data of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of EASTERNTRONIC is limited to repair and/or replacement on the terms set forth above. EASTERNTRONIC will not responsible for any subsequent or consequential events.

Declaration of conformity regarding the limitation of dangerous substances

深圳易事通液晶显示模块有限公司

SHENZHEN EASTERNTRONIC LCM CO., LTD.

4F, B3 Building , FuYuan Industrial Zone , FuYong Town,

BaoAn District, ShenZhen, P.R. China

DECLARATION OF CONFORMITY REGARDING THE LIMITATION OF									
DANGEROUS SUBSTANCES									
WE, SHENZHEN EASTERNTRONIC LCM CO., LTD,									
Declare that the product of GS16032A-D-BSXTSWW-100 complies									
with:									
The directive 2002/95/EC Dated 2003/01/27 regarding the									
limitation of dangerous substances, in particular to									
clause 4 which forbids the use of the following elements:									
●Lead									
• Mercury									
●Cadmium									
●Hexavalant chromium									
Polybrominated biphenyls									
Polybrominated diphenylethers									
And to the annex which points out the exempted implementations									
\Box To the directive 73/23/eec dated 1973/02/19 and the standard									
EN60335-1 regarding prohibition of following elements:									
• Oils containing polychlorinated biphenyl									
• Asbestos									
Radioactive substances									
Name: Ewing Liu /									
SHENZHEN EASTERNTRONIC LCM CO., LTD.									
Issued on September 7, 2006									
According with the proposal of Technical Adaptation									
Committee (TAC) of a limit of 0.1% by weight for lead									
hexavalent chromium, mercury, PBBs and PBDRs and 0.01% by									
weight for Cadmium									